# PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	

# **CONVEYING PARTY DATA**

Name	Execution Date
Ming Hsun Lee	11/15/2005
Chih-Chin Liao	11/15/2005
Cheemen Yu	11/21/2005
Hem Takiar	11/18/2005

## **RECEIVING PARTY DATA**

Name:	SanDisk Corporation
Street Address:	140 Caspian Court
City:	Sunnyvale
State/Country:	CALIFORNIA
Postal Code:	94089

## PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11170897

## **CORRESPONDENCE DATA**

Fax Number: (415)369-9665

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

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Correspondent Name: Brian I. Marcus, Esq.

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Address Line 4: San Francisco, CALIFORNIA 94105

ATTORNEY DOCKET NUMBER:	SAND-01072US0

NAME OF SUBMITTER: Brian I. Marcus

Total Attachments: 4

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PATENT REEL: 016809 FRAME: 0415

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> PATENT REEL: 016809 FRAME: 0416

## JOINT TO CORPORATE ASSIGNMENT

WHEREAS, the undersigned Inventors:

- (1) Ming Hsun Lee, a resident of No. 36-3, Ln 75, Lan 312, Sec 1, Ming Zu Rd, TanZu, Taichung, Taiwan, R.O.C.;
- (2) <u>Chih-Chin Liao</u>, a resident of <u>No. 140</u>, <u>Sec. 2</u>, <u>Da-Tong Rd., Yuanlin, Changhua, Taiwan</u>, R.O.C.;
  - (3) Cheemen Yu, a resident of 2 Dunraven Court, Madison, Wisconsin 53705, U.S.A.; and
  - (4) Hem Takiar, a resident of 1544 Blackfoot Drive, Fremont, California 94539, U.S.A.,

have invented certain new and useful improvements in:

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and have executed a declaration for an application for a United States Patent disclosing and identifying the invention:

1.	<del>der-red</del>	The Declaration for the application for the United States patent being executed on
		<u></u>
	Or	
2.		Said application having Application Number $\underline{11/170,897}$ and filed on the $\underline{30}^{th}$ day of
		June, 2005

WHEREAS SanDisk Corporation (hereinafter termed "Assignee"), a corporation of the State of Delaware, having a place of business at 140 Caspian Court, Sunnyvale, State of California, 94089, wishes to acquire the entire right, title and interest in and to said application and the invention disclosed therein, and in and to all embodiments of the invention, heretofore conceived, made or discovered jointly or severally by said Inventors (all collectively hereinafter termed "said invention"), and in and to any and all patents, certificates of invention and other forms of protection thereon (hereinafter termed "patents") applied for or granted in the United States and/or other countries.

NOW THEREFORE, for good and valuable consideration acknowledged by each of said Inventors to have been received in full from said Assignee:

Page 1 of 3

Attorney Docket No.: SAND-01072US0 sand/1072/1072.assignment

- 1. Said Inventors do hereby sell, assign, transfer and convey to said Assignee, the entire right, title and interest (a) in and to said application and said invention; (b) in and to all rights to apply in any or all countries of the world for patents, certificates of inventions or other governmental grants on said invention, including the right to apply for patents pursuant to the International Convention for the Protection of Industrial Property or pursuant to any other convention, treaty, agreement or understanding; (c) in and to any and all applications filed and any and all patents, certificates of inventions or other governmental grants granted on said invention in the United States or any other country, including each and every application filed and each and every patent granted on any application which is a division, substitution, or continuation of any of said applications; (d) in and to each and every reissue or extension of any of said patents; and (e) in and to each and every patent claim resulting from a reexamination certificate for any and all of said patents.
- Said Inventors hereby jointly and severally covenant and agree to cooperate with said 2. Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest herein conveyed in the United States and other countries. Such cooperation by said Inventors shall include prompt production of pertinent facts and documents, giving of testimony, executing of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for complying with any duty of disclosure; (c) for prosecuting any of said applications; (d) for filing and prosecuting substitute, divisional, continuing or additional applications covering said invention; (e) for filing and prosecuting applications for reissue of any of said patents; (f) for interference or other priority proceedings involving said invention; and (g) for legal proceedings involving said invention and any applications therefor and any patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, reexamination proceedings, compulsory licensing proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Inventors in providing such cooperation shall be paid for by said Assignee.
- 3. The terms and covenants of this Assignment shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Inventors, their respective heirs, legal representatives and assigns.

Said Inventors hereby jointly and severally warrant and represent that they have not

Dated:	Nov. 15, >00[	(1)	Ming HSun Lee
Dated: _	Nov. 15, 70=5	•	Chih-Chin Liao
Dated: _		(3)	Cheemen Yu
Dated: _	11/18/05	(4)	Hem Takiar

entered and will not enter into any assignment, contract, or understanding in conflict herewith.

Page 3 of 3

Amorpey Docket No.: SAND-01072US0 sand/1072/1072 assignment

4.

4,

Dated:	AND THE PARTY OF T	(1)	Ming Hsun Lee
Dated:	ATTER TO THE PARTY OF THE PARTY	(2)	Chih-Chin Liao
Dated:	Nov 21, 2005	(3)	Cheemen Yu
Dated:	adadanaya ayaliya isalah ka asaa asaa asaa ayaa ahaa ahaa ahaa aha	(4)	Ham Tolrier

entered and will not enter into any assignment, contract, or understanding in conflict herewith.

Said Inventors hereby jointly and severally warrant and represent that they have not

Page 3 of 3

Attorney Docket No.: \$AND-01072U\$0 sand/1072/1072-assignment

**RECORDED: 11/22/2005**